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	SPECIFICATION	
	DEVICE SPECIFICATION FOR TFT-LCD Modul MODEL No. LQ12DX01	e
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CUSTOMER'S APPROVAL	. 《李昌本書本書》	4
DATE	· '96. 8. 23	
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		ring Department 2
	TFT LCD	Development Center

TENRI LCD DEVELOPMENT GROUP

SHARP CORPORATION

RECORDS OF REVISION

LQ12DX01

SPEC No.	DATE	REVISED		SUMMARY	NOTE
		No.	PAGE		
LD-8114	Jan. 29, 1996				lst Issue
LD-8114X	Aug. 19, 1996		1	Append: Sentence of PL	
//	"	"	2	Correction:Active area	
	"	//	2	Change:Haze value 6 → 25	
	"	//	7	Change: [Note2]	
"	"	"	77	Correction: [Note5] 1300Vrms→1400Vrms	<u></u>
"	"	"	8	Correction:備考 → Remark	
//	//	"	9	Correction:(7-2) clock → line	
//	"	"	12	Correction:Vcc=+3.3V → Vcc=+5V	
″	//	//	12	Correction: θ 21/ θ 22=45 \rightarrow 35	
″	//	"	12	Change:YL(Min/Typ)=50/70 → 60/80	
"	"	"	15	Append:Suffix LQ12DX01→ LQ12DX01-A	
"	"	"	16	Append:location of CN2-Pinl	
"	"		17	Append:Suffix LQ12DX01→ LQ12DX01-A	
"	"	"	17	Correction: 1) name of connector CN1	
"	"	"	17	Correction: 2) \rightarrow 3)	
"	"	"	18	Append:Suffix LQ12DX01→ LQ12DX01-A	
		<u> </u>			
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			<u>_</u>		

1. Application

This specification applies to a color TFT-LCD module, LQ12DX01.



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2. Overview

This module is a color active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor). It is composed of a color TFT-LCD panel, driver ICs, control circuit and power supply circuit and a backlight unit. Graphics and texts can be displayed on a $1024 \times 3 \times 768$ dots panel with 262.144 colors by using LVDS (Low Voltage Differential Signaling) to interface and supplying +5V DC supply voltage for TFT-LCD panel driving and supply voltage for backlight.

The TFT-LCD panel used for this module has high aperture ratio. A low-reflection and higher-color-saturation type color filter is also used for this panel. Therefore, high-brightness and high-contrast image, which is suitable for the multimedia use, can be obtained by using this module.

Optimum viewing direction is 6 o'clock.

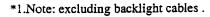
Backlight-driving DC/AC inverter is not built in this module.

[Features]

- 1) High aperture panel; high-brightness or low power consumption.
- 2) Brilliant and high contrast image.
- 3) Small footprint and thin shape.
- 4) Light weight.

3. Mechanical Specifications

viecnanicai Specifications		T	٦
Parameter	Specifications	Unit	╛
Display size	31 (Diagonal)	cm	
	12.1 (Diagonal)	inch	
Active area	245.8 (H)×184.3 (V)	mm	
Pixel format	1024 (H)×768 (V)	pixel	
	(1 pixel = R + G + B dots)		
Pixel pitch	0.24 (H) × 0.24 (V)	mm	
Pixel configuration	R,G,B vertical stripe		
Display mode	Normally white		
Unit outline dimensions *1	$275 \text{ (W)} \times 202.5 \text{ (H)} \times 9.2 \text{(D)}$	nm	
Mass	590 ± 30	g	
Surface treatment	Anti-glare and hard-coating 2H		
	(Haze value = 25)		



Outline dimensions is shown in Fig.1



4. Input Terminals

4-1. TFT-LCD panel driving

CN1.(LVDS signals and +5V DC power supply)
Using connector: DF14A-20P-1.25H(Hirose Electric)

Corresponding connector: DF14-20S-1.25C (")

Pin No.	Symbol	Function	Remark
1	Vcc	+5V power supply	
2	Vcc	+5V power supply	
3	GND		
4	GND		
5	RIINO-	Receiver signal of odd pixels (-)	LVDS
6	R1IN0+	Receiver signal of odd pixels (+)	LVDS
7	R1IN1-	Receiver signal of odd pixels (-)	LVDS
8	R1IN1+	Receiver signal of odd pixels (+)	LVDS
9	R1IN2-	Receiver signal of odd pixels (-)	LVDS
10	R1IN2+	Receiver signal of odd pixels (+)	LVDS
11	CK1IN-	Clock signal of odd pixels (-)	LVDS
12	CK1IN+	Clock signal of odd pixels (+)	LVDS
13	R2IN0-	Receiver signal of even pixels (-)	LVDS
14	R2IN0+	Receiver signal of even pixels (+)	LVDS
15	R2IN1-	Receiver signal of even pixels (-)	LVDS
16	R2IN1+	Receiver signal of even pixels (+)	LVDS
17	R2IN2-	Receiver signal of even pixels (-)	LVDS
18	R2IN2+	Receiver signal of even pixels (+)	LVDS
19	CK2IN-	Clock signal of even pixels (-)	LVDS
20	CK2IN+	Clock signal of even pixels (+)	LVDS

[Note 1] Relation between LVDS signals and actual data shows below section (4-2).

[Note 2] The shielding case is connected with signal GND.



4-2. Interface block diagram

TxIN 18~20 must be fixed "Low". Controller B10~B15 G10~G15 R10~R15 B20~B25 G20~G25 R20~R25 ENAB Hsync Vsync CLK 16 6 6 TxIN 6~TxINII 6 TxIN 0~TxIN 5 (Computer side) TxIN12~TxIN17 Using receiver: DS90CR562(National semiconductor) Corresponding Transmitter: DS90CR561,DS90CF561,DS90CR581,DS90CF581(National semiconductor) Tx IN12~Tx IN17 TxIN 6~TxINI1 TxIN 0~TxIN 5 even pixels odd pixels ₹ TxCLK IN TxIN19 Tx IN20 TxIN18 TxCLK TxIN18 TxIN20 TxIN19 DS90C*561)S90C*561 PLL PLL TTL parallel \rightarrow LVDS TTL parallel → LVDS CK11N+ (12) R11NO (5) R2IN2-(17) CK11N-(11) RLIN2-(9) R11N2+(10) R11N1-(7) RI INI+ (8) R11N0+(6) CK21N-(19) CK21N+ (20) R21N2+ (18) R21N1-(15) R21N1+(16) R21NO-(13) R21N0+(14) Symbol of CNI (Pin No.) DS90CR562 DS90CR562 PLL PLL LVDS \rightarrow TTL parallel \rightarrow TTL parallel LVDS Rx0UT18 RXOUT 6~RXOUT11 & G10~G15 Rx0UT20 RxOUT 19 RXOUT12~RXOUT17 & B20~B25 RxOUT19 Rx0UT12~Rx0UT17 RXOUT 0~RXOUT 5 6 R10~R15 RX0UT 6~RX0UT11 6 G20~G25 Rx0UT20 RxCLK OUT RXOUT 0~RXOUT 5 6 R20~R25 RxCLK OUT (TFT-LCD side) -Vsync B10~B15 CK1 ENAB Hsync CK2 Reserved Reserved Reserved Internal circuits

LD8114-4

4-3. Backlight driving

CN2:BHR-03VS-1(JST)

Mating connector: SM02(8.0)B-BHS(JST)

Triating Commedia: Divida(C.C.C)					
Pin no.	symbol	function			
1	V _{HIGH}	Power supply for lamp			
		(High voltage side)			
2	NC	This is electrically opened.			
3	V _{LOW}	Power supply for lamp			
		(Low voltage side)			

5. Absolute Maximum Ratings

Parameter	Symbol	Condition	Ratings	Unit	Remark
Input voltage	V _I	Ta=25℃	$-0.3 \sim \text{Vcc+0.3}$	v	[Note1]
+5.0V supply voltage	Vcc	Ta=25℃	0~+6	v	
Storage temperature	Tstg	-	$-25 \sim +60$	က	[Note2]
Operating temperature (Ambient)	Topa	_	0 ~ +50	ಌ	

[Note1] LVDS signals

[Note2] Humidity: 95%RH Max. at $Ta \le 40$ °C.

Maximum wet-bulb temperature at 39°C or less at Ta>40°C.

No condensation.

6. Electrical Characteristics

6-1. TFT-LCD panel driving

Ta=25℃

** ** *	CCD paner driving							14 200
	Parameter		Symbol	Min.	Тур.	Max.	Unit	Remark
Vcc	Supply voltage		Vcc	+4.5	+5.0	+5.5	V	[Note2]
	Current dissipation		Icc	_	320	580	mA	[Note3]
Permis	sive input ripple voltag	e	V _{RP}	_	_	100	mA	Vcc=+5.0V
Differe	ential input	High	V _{IH}	-		+100	V	V _{CM} =+1.2V
thresho	old voltage	Low	Vπ	-100	_	-	V	[Note1]
Input c	urrent (High)		Гон	_	-	±10	μΑ	V _I =2.4V
							Vcc=5.5V	
Input current (Low)		I _{OL}	_	, -	±10	μΑ	V _I =0V	
								Vcc=5.5V

[Note1] V_{CM}: Common mode voltage of LVDS driver.



Vcc

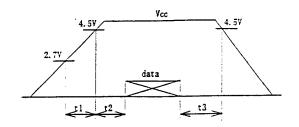
[Note2]

Vcc-turn-on conditions

 $0 \le tl \le 10ms$

 $0 < t2 \le 10 ms$

0<3≦1s

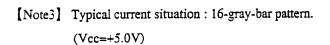


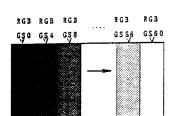
td >

Vcc-dip conditions

- 1) 2.7V≦Vcc<4.5V td≤10ms
- 2) Vcc<2.7V

Vcc-dip conditions should also follow the Vcc-turn-on conditions



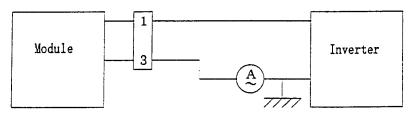


6-2. Backlight driving

The backlight system is an edge-lighting type with single CCFT (Cold Cathode Fluorescent Tube). The characteristics of the lamp are shown in the following table.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark	
Lamp current range	IL.	2.5	5.0	6.0	mArms	[Note1]	
Lamp voltage	V _L	_	600	_	Vms		
Lamp power consumption	PL	_	3.0	_	W	[Note2]	
Lamp frequency	FL	20	35	60	KHz	[Note3]	
Kick-off voltage	Vs	-	_	1300	Vrms	Ta=25℃	
		_	_	1400	Vrms	Ta=0°C	[Note4]
Lamp life time	Lı	10000		_	hour	[Note5]	

[Note1] Lamp current is measured with current meter for high frequency as shown below.



* 3pin is V LOW



[Note2] Calculated value for reference (IL × VL)

[Note3] Lamp frequency may produce interference with horizontal synchronous frequency, and this may cause beat on the display. Therefore lamp frequency shall be detached as much as possible from the horizontal synchronous frequency and from the harmonics of horizontal synchronous to avoid interference.

[Note4] The voltage above this value should be applied to the lamp for more than 1 second to startup. Otherwise the lamp may not be turned on.

[Note5] Lamp life time is defined as the time when either ① or ② occurs in the continuous operation under the condition of Ta=25°C and IL=6.0mArms.

① Brightness becomes 50% of the original value under standard condition.

② Kick-off voltage at Ta=0°C exceeds maximum value, 1400 Vrms.

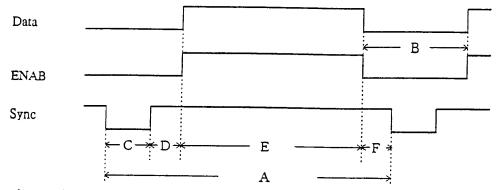
Note) The performance of the backlight, for example life time or brightness, is much influenced by the characteristics of the DC-AC inverter for the lamp. When you design or order the inverter, please make sure that a poor lighting caused by the mismatch of the backlight and the inverter (miss-lighting, flicker, etc.) never occur. When you confirm it, the module should be operated in the same condition as it is installed in your instrument.



7. Timing characteristics of input signals

7-1. Timing characteristics

(This is specified at digital outputs of LVDS driver.)



(Vertical)

Item (symbol)	Min.	Тур.	Max.	Unit	Remark
Vsync cycle (T _{vA})	_	16.667	_	ms	negative
	803	806	_	line	1
Blanking period(T _{VB})	35	38		line	
Sync pulse width (T _{VC})	4	6	-	line	
back porch (T _{VD})	0	29		line	
Sync pulse width+Back porch (T _{vc} +T _{vp})	35	35	35	line	
Active display area (T ve)	768	768	768	line	
Front porch (T _{vF})	0	3		line	

(Horizontal)

Item (symbol)	Min.	Тур.	Max.	Unit	Remark
Hsync cycle (T HA)	19.2	20.677	_	μs	Negative
	520	672	_	clock	1
Blanking period (T HB)	8	160	_	clock	
sync pulse width (T HC)	4	68		clock	
Back porch (T HD)	0	80	-	clock	
Active display area (T HE)	512	512	512	clock	
Front porch (T _{HF})	4	12		clock	

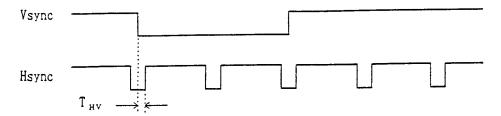
(Clock)

Item	Min.	Тур.	Max.	Unit	Remark
Frequency	25.0	32.5	37. <i>5</i>	MHz	[Note1]

[Note1] Two pixel-data are sampled at a time.

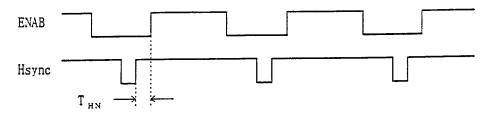


(Hsync-Vsync Phase difference)



Item(symbol)	Min.	Тур.	Max.	Unit	Remark	
Hsync-Vsync Phase difference(T HV)	1	1	$T_{HA}-T_{HC}$			

(Hsync-ENAB Phase difference)



Item	Min.	Typ.	Max.	Unit	Remark
(T _{HN})	0	_	156	clock	

7-2 Display position

Item	Standards	Beginning	Ending	Unit Remark
Horizontal	rising edge of ENAB	0	512	clock
	falling edge of Hsync	148	660	clock [Note1]
Vertical	falling edge of Vsync	35	803	line



[Note1] ENAB signal must be fixed to low.

Note)

(Horizontal display direction)

When ENAB is fixed low, 148 clock are counted from Hsync falling edge and data from after are available. If you need other timing, please use ENAB signal.

(Vertical display direction)

35 lines are counted from Vsync falling edge and data from next line are available.

(Note of ENAB signal)

ENAB could not be used for the purpose of the vertical display start timing.

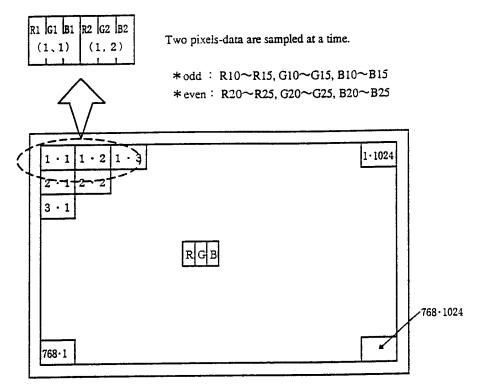
Caution

Image will not be displayed on the right position otherwise.



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7-3 Input Data Signals and Display Position on the screen



Display position of input data (V \cdot H)

-11

	8. Input Signals. Basic Display Colors and Gray Scale of Each Color																			
	Colors &			D	ata si	gnal			1						1					
	Gray scale	GrayScale	R10	R11	R12	R13	R14	R15	G10	G11	G12	G13	G14	G15	B10	B11	B12	B13	B14	B 15
-			R20	R21	R22	R23	R24	R25	G20	G21	G22	G23	G24	G25	B20	B21	B22	B23	B24	B25
	Black		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	_	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
5	Green		0	0	0	0	0	0	1	1	1	i	1	1	0	0	0	0	0	0
Basic	Cyan	_	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	11	1
Color	Red		1	1	1	1	1	1	0	0	0	0	0	0	0	0	0_	0_	0	0
²	Magenta		1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow		1	1	11	11	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	_	1	1	1	1	1	1_	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0_	0	0	0	0	0	0	0	0	0
Gray	Û	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Darker	GS2	0	1	0	0	0	.0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	Û	\	↓ ↓						\						4					
of	û	4	V					V						4						
Red	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS62	0	1	1	11	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Û	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
Scale	Û	V	+						.						V					
of	û	₩			1	,					1	<u> </u>								
Green	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
ň	û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
	Green	GS63	0	0	0	0	0	0	1	1	1	1	l	1	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gra	Û	GS1	0	0	0	0	0	0	0	0	ዑ	0	0	0	1	0	0	0	0	0
y Sc	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
ale	Ŷ	Ψ	. \						\								1	•		
of	û	V	↓					V						Ψ						
Gray Scale of Blue	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0_	0	1	0	1	1	1	1
	Û	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	Blue	GS63	0	0	0 .	. 0	0	0	0	0	0	0	0	0	1_	1	1	1	1	1

0:Low level voltage, 1: High level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.



9. Optical Characteristics

. Opiica c							Ta=25℃	, Vcc=+5V	<u> </u>
Par	ameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	
Viewing Horizontal		θ 21, θ 22	CR>10	35	_	+	Deg.	[Note1,4]	
angle	Vertical	θ 11		10	_		Deg.		
range		θ 12		30			Deg.		
	Contrast ratio		θ =0°	100				[Note2,4]	
Response		τι			30		m s	[Note3,4]	
time	Decav	τd		_	50		m s	·	
Chromaticity of		x		_	0.313	_		[Note4]	
white		у		_	0.329	_			
Luminance of white		YL		60	80	_	cd/m²	IL=5.0mArms	
								[Note4]	
White Uniformity δ w				_		1.45		[Note5]	

 $*The measurement shall be executed 30 minutes after lighting at rating. (typical condition: <math>I_L=5.0$ mArms) The optical characteristics shall be measured in a dark room or equivalent state with the method shown in Fig.2 below.

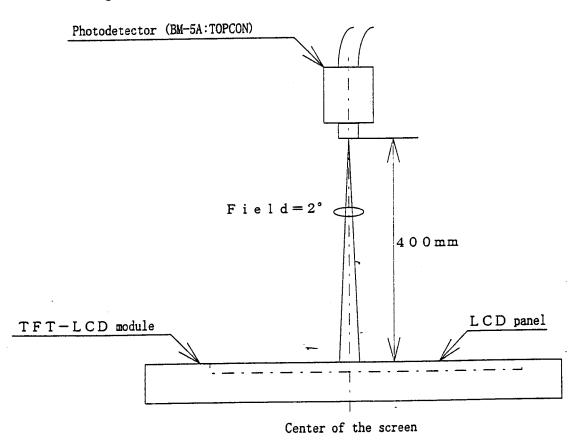
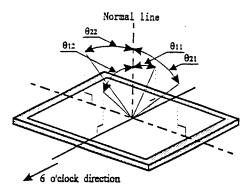


Fig. 2 Optical characteristics measurement method

[Note1] Definitions of viewing angle range:

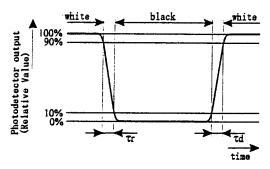


[Note2] Definition of contrast ratio:

The contrast ratio is defined as the following.

[Note3] Definition of response time:

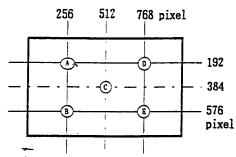
The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



[Note4] This shall be measured at center of the screen.

[Note5] Definition of white uniformity:

White uniformity is defined as the following with five measurements $(A \sim E)$.



δ w =

Maximum Luminance of five points (brightness)

Minimum Luminance of five points (brightness)

10. Display Quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standard.

11. Handling Precautions

- a) Be sure to turn off the power supply when inserting or disconnecting the cable.
- b) Be sure to design the cabinet so that the module can be installed without any extra stress such as warp or twist.
- c) Since the front polarizer is easily damaged, pay attention not to scratch it.
- d) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- e) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- f) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface. Handle with care.
- g) Since CMOS LSI is used in this module, take care of static electricity and injure the human earth when handling.
- h) Observe all other precautionary requirements in handling components.
- i) This module has its circuitry PCBs on the rear side and should be handled carefully in order not to be stressed.
- j) Laminated film is attached to the module surface to prevent it from being scratched. Peel the film off slowly just before the use with strict attention to electrostatic charges. Ionized air shall be blown over during the action. Blow off the 'dust' on the polarizer by using an ionized nitrogen gun, etc..

12. Packing form

- a) Piling number of cartons: MAX. 7
- b) Packing quantity in one carton: 10 pcs
- c) Carton size: $315(W) \times 380(H) \times 380(D)$ mm
- d) Total mass of one carton filled with full modules: 8300g

Packing form is shown in Fig.3.

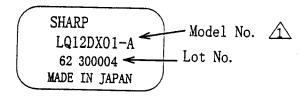


13. Reliability test items

		
No.	Test item	Conditions
1	High temperature storage test	Ta=60°C 240h
2	Low temperature storage test	Ta=-25°C 240h
3	High temperature	Ta=40°C;95%RH 240h
	& high humidity operation test	(No condensation)
4	High temperature operation test	Ta=50°C 240h
		(The panel temp, must be less than 60°C)
5	Low temperature operation test	Ta=0°C 240H
6	Vibration test	Frequency: 10~57Hz/Vibration width (one side):0.075mm
	(non-operating)	: 58~500Hz/Gravity:9.3m/s2
		Sweep time: 11 minutes
		Test period: 3 hours
		(1 hour for each direction of X,Y,Z)
7	Shock test	Max. gravity: 490m/s ²
	(non- operating)	Pulse width: 11ms, sine wave
		Direction: $\pm X, \pm Y, \pm Z$
		once for each direction.

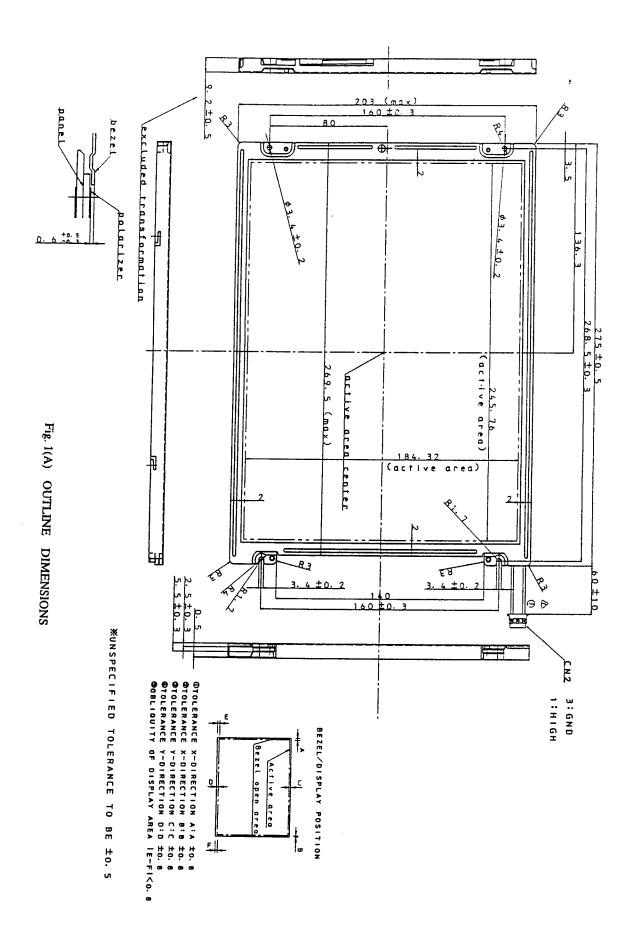
14. Others

1) Lot No. Label:



- 2) Adjusting volume have been set optimally before shipment, so do not change any adjusted value. If adjusted value is changed, the specification may not be satisfied.
- 3) Disassembling the module can cause permanent damage and should be strictly avoided.
- 4) Please be careful since image retention may occur when a fixed pattern is displayed for a long time.
- 5) If any problem occurs in relation to the description of this specification, it shall be resolved through discussion with spirit of cooperation.





LD8114-16

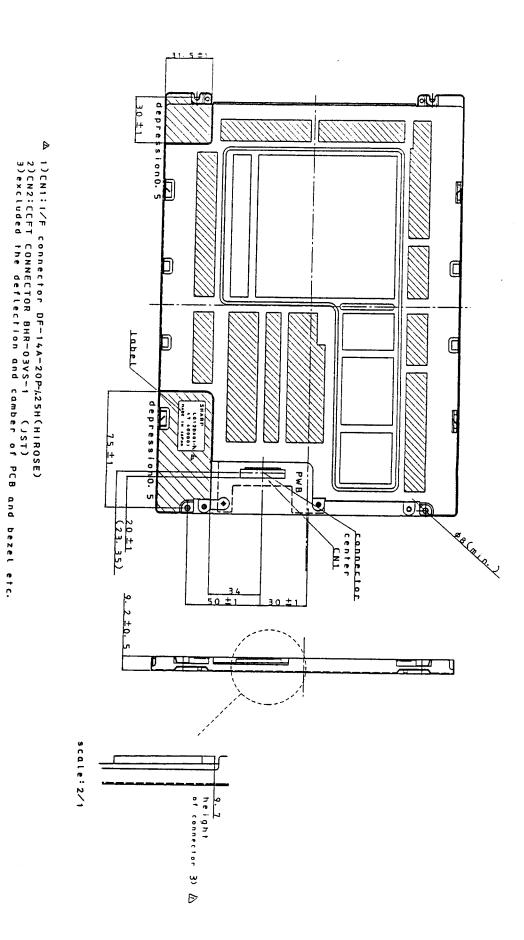


Fig. 1(B) OUTLINE DIMENSIONS

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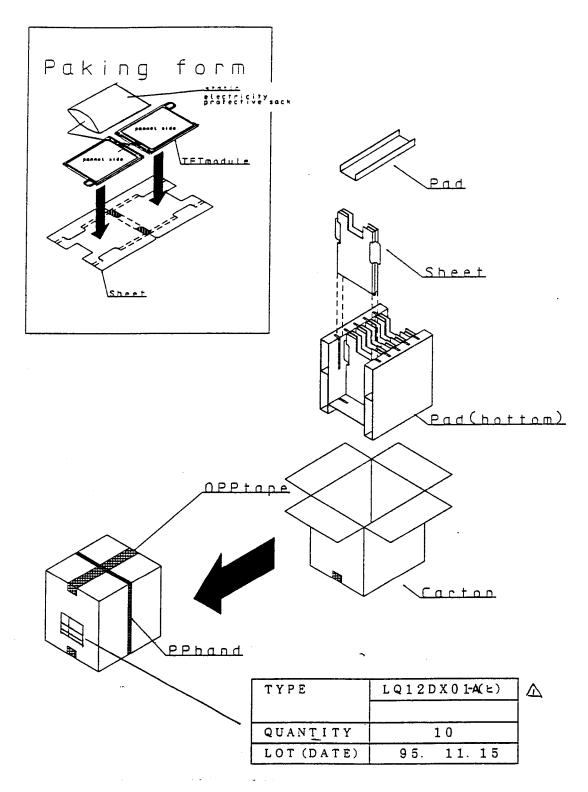


Fig. 3 PACKING FORM

SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.

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